# 74AHC1G126; 74AHCT1G126

Bus buffer/line driver; 3-state

Rev. 06 — 25 May 2007

**Product data sheet** 

#### **General description** 1.

74AHC1G126 and 74AHCT1G126 are high-speed Si-gate CMOS devices.

They provide one non-inverting buffer/line driver with 3-state output. The 3-state output is controlled by the output enable input pin (OE). A LOW at pin OE causes the output to assume a high-impedance OFF-state.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

#### **Features** 2.

- - CDM JESD22-C101C: exceeds 1000 V
- Specified from -40 °C to +125 °C

#### **Ordering information** 3.

**Ordering information** Table 1.

Type number	Package								
	Temperature range	Name	Description	Version					
74AHC1G126GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads;	SOT353-1					
74AHCT1G126GW			body width 1.25 mm						
74AHC1G126GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753					
74AHCT1G126GV									

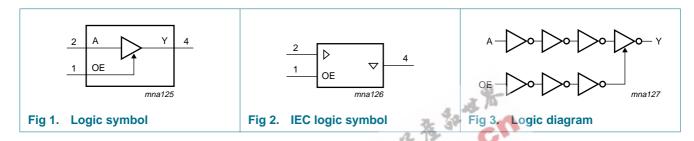


# 4. Marking

Table 2. Marking codes

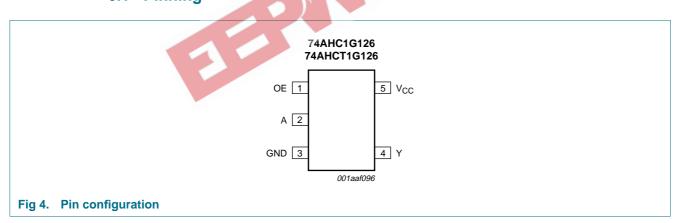
Type number	Marking
74AHC1G126GW	AN
74AHC1G126GV	A26
74AHCT1G126GW	CN
74AHCT1G126GV	C26

# 5. Functional diagram



# 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
OE	1	output enable input
A	2	data input A
GND	3	ground (0 V)
Υ	4	data output Y
V <sub>CC</sub>	5	supply voltage

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# 7. Functional description

Table 4. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ Z = high-impedance \ OFF-state$ 

Input	Output	
OE	A	Υ
Н	L	L
Н	Н	Н
L	X	Z

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
$V_{I}$	input voltage		-0.5	+7.0	V
$I_{IK}$	input clamping current	$V_{I} < -0.5 \text{ V}$	<b>-2</b> 0	-	mA
$I_{OK}$	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ -0.5 V < $V_O < V_{CC} + 0.5 \text{ V}$	<u>[1]</u> -	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		±25	mA
$I_{CC}$	supply current	Co	-	75	mA
$I_{GND}$	ground current		<b>-75</b>	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[2] _	250	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74	AHC1G1	26	74AHCT1G126			Unit
			Min	Тур	Max	Min	Тур	Max	
$V_{CC}$	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
$V_{I}$	input voltage		0	-	5.5	0	-	5.5	V
$V_{O}$	output voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 3.3 V $\pm$ 0.3 V	-	-	100	-	-	-	ns/V
		$V_{CC}$ = 5.0 V $\pm$ 0.5 V	-	-	20	-	-	20	ns/V

<sup>[2]</sup> For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

# 10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G126	'		'						
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
$V_{OH}$	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = -50 \mu\text{A};  V_{CC} = 2.0 \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu\text{A};  V_{CC} = 3.0 \text{V}$	2.9	3.0	-	2.9	Q	2.9	-	V
		$I_{O} = -50 \mu A$ ; $V_{CC} = 4.5 V$	4.4	4.5	-	4.4	/10	4.4	-	V
		$I_O = -4.0 \text{ mA}$ ; $V_{CC} = 3.0 \text{ V}$	2.58	-	12. 7	2.48	CL	2.40	-	V
		$I_{O} = -8.0 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	3.94	-%	'A'	3.8		3.70	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$			m (	34.				
	output voltage	$I_0 = 50 \mu\text{A};  V_{CC} = 2.0 \text{V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu\text{A};  V_{CC} = 3.0 \text{V}$		0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \mu\text{A};  V_{CC} = 4.5 \text{V}$	7	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
$I_{OZ}$	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10	μΑ
l <sub>1</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
C <sub>I</sub>	input capacitance		-	3	10	-	10	-	10	pF
For type	74AHCT1G126									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
<b>-</b> 11	output voltage	$I_{O} = -50 \mu\text{A}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -8.0 \text{ mA}$	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
<u>-</u>	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V

Table 7. Static characteristics ... continued Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C 1	to +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
$I_{OZ}$	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10	μΑ
II	input leakage current	$V_{I} = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to 5.5 V}$	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $I_O = 0 \text{ A};$ $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
Cı	input capacitance		-	3	10	-	10	-	10	pF

# 11. Dynamic characteristics

**Dynamic characteristics** Table 8.

11. Dy	ynamic c	haracteristics					3	*			
able 8.	Dynamic c	haracteristics 0 ns. For test circuit see F	igure 7.		3	为节	W.	to +85 °C			
Symbol	Parameter	Conditions		Min	<b>2</b> 5 °C <b>T</b> yp	Max	–40 °C : Min	to +85 °C Max	–40 °C t Min	o +125 °C Max	Uni
For type	74AHC1G12	6	- 1/	Willi	Тур	IVIAX	IVIIII	IVIAX	IVIIII	IVIAX	
	propagation		[1]								
pd	delay	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[2]								
		$C_L = 15 \text{ pF}$	:	_	4.4	8.0	1.0	9.5	1.0	10.0	ns
		$C_L = 50 \text{ pF}$		_	6.3	11.5	1.0	13.0	1.0	14.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]		0.0	11.0	1.0	10.0			110
		C <sub>L</sub> = 15 pF		-	3.4	5.5	1.0	6.5	1.0	7.0	ns
		$C_1 = 50 \text{ pF}$		-	4.7	7.5	1.0	8.5	1.0	9.5	ns
en	enable time	OE to Y; see Figure 6	[1]								
		V <sub>CC</sub> = 3.0 V to 3.6 V	[2]								
		C <sub>L</sub> = 15 pF		-	4.9	8.0	1.0	9.5	1.0	10.0	ns
		C <sub>L</sub> = 50 pF		-	7.0	11.5	1.0	13.0	1.0	14.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		C <sub>L</sub> = 15 pF		-	3.6	5.6	1.0	6.3	1.0	7.0	ns
		$C_L = 50 pF$		-	5.4	8.0	1.0	9.0	1.0	9.5	ns
dis	disable time	OE to Y; see Figure 6	<u>[1]</u>								
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[2]								
		$C_L = 15 pF$		-	6.3	9.7	1.0	11.5	1.0	12.5	ns
		$C_L = 50 pF$		-	9.0	13.2	1.0	15.0	1.0	16.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		$C_L = 15 pF$		-	4.3	6.8	1.0	8.0	1.0	8.5	ns
		$C_{L} = 50 \text{ pF}$			6.1	8.8	1.0	10.0	1.0	11.0	

 Table 8.
 Dynamic characteristics ...continued

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For test circuit see Figure 7.

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
$C_{PD}$	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$ ; $f = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$	<u>[4]</u>	-	9	-	-	-	-	-	pF
For type	74AHCT1G1	26									
t <sub>pd</sub>	propagation	A to Y; see Figure 5	<u>[1]</u>								
	delay	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		C <sub>L</sub> = 15 pF		-	3.4	5.5	1.0	6.5	1.0	7.0	ns
		$C_L = 50 pF$		-	4.7	7.5	1.0	8.5	1.0	9.5	ns
t <sub>en</sub>	enable time	OE to Y; see Figure 6	<u>[1]</u>								
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		C <sub>L</sub> = 15 pF		-	3.4	5.6	1.0	6.3	1.0	6.5	ns
		$C_L = 50 pF$		-	4.8	8.0	1.0	9.0	1.0	9.0	ns
t <sub>dis</sub>	disable time	OE to Y; see Figure 6	<u>[1]</u>					15			
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]			-20	34	-10			
		C <sub>L</sub> = 15 pF			4.0	6.8	1.0	8.0	1.0	8.5	ns
		C <sub>L</sub> = 50 pF			5.7	8.8	1.0	10.0	1.0	11.5	ns
$C_{PD}$	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$ ; $f = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$	[4]	1	11	.C.	<b>)</b> -	-	-	-	pF

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
  - ten is the same as tPZL and tPZH.
  - $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [2] Typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .
- [3] Typical values are measured at  $V_{CC} = 5.0 \text{ V}$ .
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

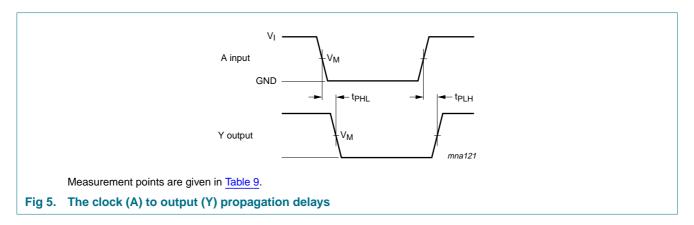
 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in Volts.

# 12. Waveforms



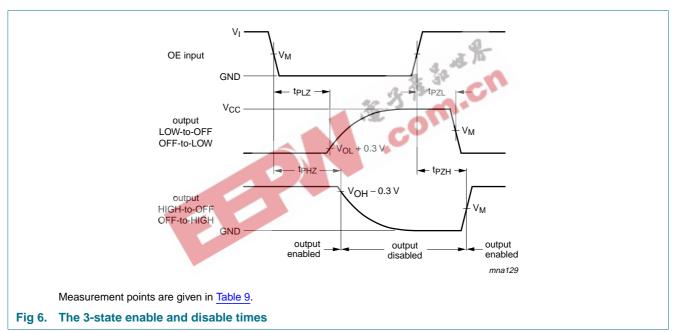
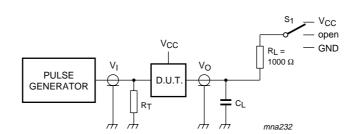


Table 9. Measurement points

Туре	Input	Output	
	V <sub>M</sub>	V <sub>I</sub>	V <sub>M</sub>
74AHC1G126	$0.5 \times V_{CC}$	GND to V <sub>CC</sub>	$0.5 \times V_{CC}$
74AHCT1G126	1.5 V	GND to 3.0 V	$0.5 \times V_{CC}$



For test data see Table 8. Definitions for test circuit:

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

For  $t_{PLH}$ ,  $t_{PHL}$ ,  $S_1 = open$ 

For  $t_{PLZ}$ ,  $t_{PZL}$ ,  $S_1 = V_{CC}$ 

For  $t_{PHZ}$ ,  $t_{PZH}$ ,  $S_1 = GND$ 

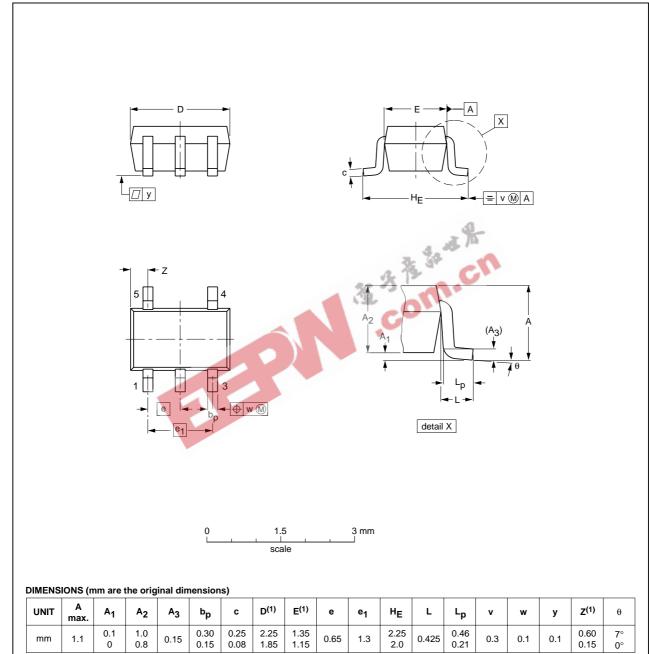
Fig 7. Load circuitry for switching times



# 13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT353-1		MO-203	SC-88A			<del>00-09-01</del> 03-02-19	

Fig 8. Package outline SOT353-1 (TSSOP5)

#### **SOT753** Plastic surface-mounted package; 5 leads В Α Х = v M A 5 Q detail X **-**⊕ w M B 2 mm **DIMENSIONS** (mm are the original dimensions) UNIT Α1 D Ε Α bp С Q е ΗE Lp w у 0.100 0.40 0.26 0.33 1.1 3.1 1.7 3.0 0.6 0.95 0.2 0.1 0.2 0.013 0.10 0.9 **REFERENCES** EUROPEAN OUTLINE **ISSUE DATE PROJECTION VERSION** IEC **JEDEC** JEITA 02-04-16 SOT753 SC-74A 06-03-16

Fig 9. Package outline SOT753 (SC-74A)

### 14. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 15. Revision history

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT1G126_6	20070525	Product data sheet	- 4-	74AHC_AHCT1G126_5
Modifications:	Typos in or	dering numbers correcte	ed in Table 1 "Ordering	information".
74AHC_AHCT1G126_5	20070514	Product data sheet	在 答 C	74AHC_AHCT1G126_4
Modifications:	<ul> <li>Package S</li> </ul>	OT353 changed to SOT	353-1 in <u>Section 3</u> and	Section 13.
	<ul> <li>Quick refer</li> </ul>	ence data and Soldering	sections removed.	
	<ul><li>Section 2 "</li></ul>	Features" updated.		
		of this data sheet has be of NXP Semiconductors.	•	mply with the new identity
	<ul><li>Legal texts</li></ul>	have been adapted to the	ne new company nam	e where appropriate.
74AHC_AHCT1G126_4	20020606	Product specification	-	74AHC_AHCT1G126_3
74AHC_AHCT1G126_3	20020215	Product specification	-	74AHC_AHCT1G126_2
74AHC_AHCT1G126_2	20010406	Product specification	-	74AHC1G_AHCT1G126_1
74AHC1G AHCT1G126 1	19990920	Product specification	-	-

### 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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